

99-216/Y2C-AR2T1B/FC

Features

- Side view white LED.
- White SMT package.
- Lead frame package with individual 2 pins.
- 'Wide viewing angle.
- ' Soldering methods: IR reflow soldering.
- ' Pb-free.
- The product itself will remain within RoHS compliant version.



Descriptions

Due to the package design, 99-216 has wide viewing angle, low power consumption and white LEDs are devices which are materialized by combing Blue LEDs and specialphosphors .This feature makes the LED ideal for light guide application.

Applications

- LCD back light.
- ' Mobile phones .
- Indicators.
- 'Illuminations.
- Switch lights.

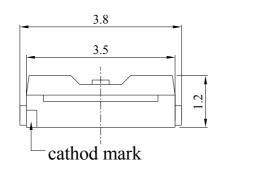
Device Selection Guide

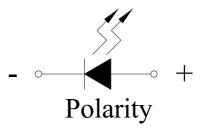
Chip			
Material	Emitted Color	Resin Color	
AlGaInP	Brilliant Yellow	Water Clear	

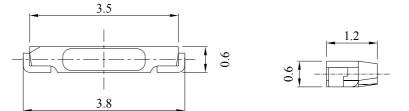


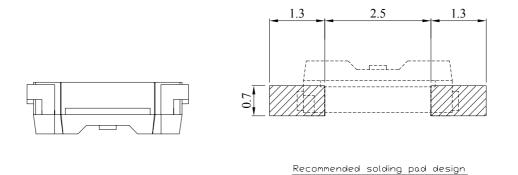
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Package Outline Dimensions









Notes: Tolerances Unless Dimension ± 0.1 mm ,Unit = mm

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EVERLIGHT ELECTRONICS CO.,LTD.

Technical Data Sheet Side View LED (0.6mm)

99-216/Y2C-AR2T1B/FC

Absolute Maximum Rat	111 <u>5</u> 5 (1 u -2c		h . I	D - 4'			T	
Parameter			Symbol		Rating		Unit	
Reverse Voltage			V _R		5		V	
Forward Current	nt	I	$I_{\rm F}$		50		mA	
Peak Forward Current (Duty	1/10 @1KHz) I _F	$I_{\rm FP}$		100		mA	
Power Dissipati	on	Р	Pd		120		mW	
Electrostatic Discharg	e(HBM)	ES	ESD		2000		V	
Operating Temperature		То	pr	-40 ~ +85				
Storage Temperature		Ts	tg	-40 ~ +90				
Soldering Temperature		Ts	sol	Reflow Soldering Hand Soldering : 3				
Electro-Optical Charac	teristics (Ta	=25)						
Parameter	Symbol	Min.	Тур.	Max.	Unit	t	Condition	
Luminous Intensity	I _V	140		360	mcd	l	I _F =20mA	
Viewing Angle	201/2		110		deg		I _F =20mA	
Peak Wavelength	λp		591		nm		I _F =20mA	
Dominant Wavelength	λd	585.5		594.5	nm		I _F =20mA	
Spectrum Radiation Bandwidth	λ		15		nm		I _F =20mA	
Forward Voltage	\mathbf{V}_{F}	1.75		2.35	V		I _F =20mA	
Reverse Current	I _R			10	μA		V _R =5V	

Absolute Maximum Ratings (Ta=25)

Notes:

1. Tolerance of Luminous Intensity $\pm 11\%$

2.Tolerance of Dominant Wavelength ±1nm

3. Tolerance of Forward Voltage ± 0.1 V

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Bin Range of Luminous Intensity

Bin	Min.	Max.	Unit	Condition
R2	140	180		I _F =20mA
S1	180	225		
S2	225	285	mcd	
T1	285	360		

Bin Range of Dominant Wavelength

Group	Bin Code	Min.	Max.	Unit	Condition	
	D3	585.5	588.5			
А	D4	588.5	591.5	nm	I _F =20mA	
	D5	591.5	594.5			

Bin Range of Forward Voltage

Group	Bin.	Min.	Max.	Unit	Condition
	0	1.75	1.95		
В	1	1.95	2.15	V	I _F =20mA
	2	2.15	2.35		

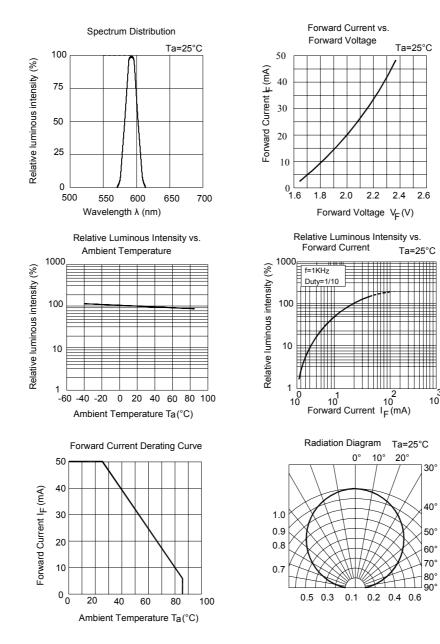
Notes:

- 1.Tolerance of Luminous Intensity $\pm 11\%$
- 2. Tolerance of Dominant Wavelength ± 1 nm
- 3.Tolerance of Forward Voltage $\pm 0.1V$



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Typical Electro-Optical Characteristics Curves



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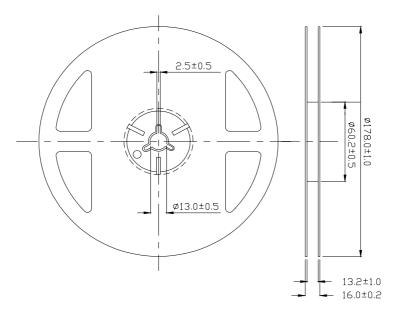
Label Explanation

CAT: Luminous Intensity Rank HUE: Dom. Wavelength Rank REF: Forward Voltage Rank

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Reel Dimensions



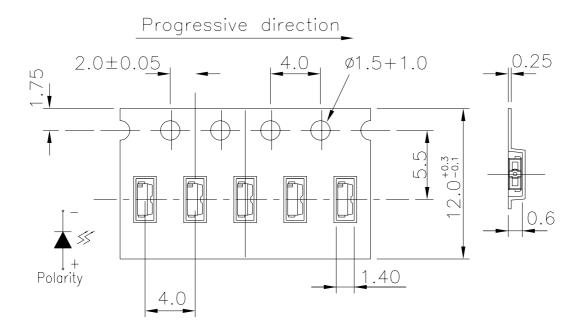
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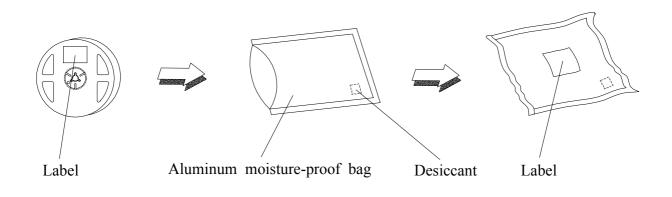
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Carrier Tape Dimensions; Loaded Quantity 3500 pcs Per Reel



Note: Tolerances Unless Dimension ±0.1mm ,,Unit = mm

Moisture Resistant Packaging



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Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below. Confidence level : 90% LTPD : 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260 ±5 Min. 5 sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H : +100 15min ∫ 5 min L : -40 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H:+100 5min $\int 10 \sec C$ L:-10 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_{\rm F} = 20 \ {\rm mA} \ / \ 25$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85 /85%RH	1000 Hrs.	22 PCS.	0/1

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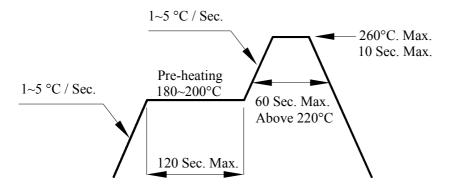
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Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30 or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30 deg C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.Baking treatment : 60±5 for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.
- 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350 for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

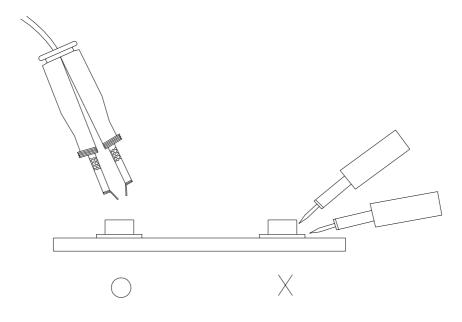
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5. Repairing

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Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



6. Handling Indications

During processing, mechanical stress on the surface should be minimized as much as possible. Sharp objects of all types should not be used to pierce the sealing compound

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